



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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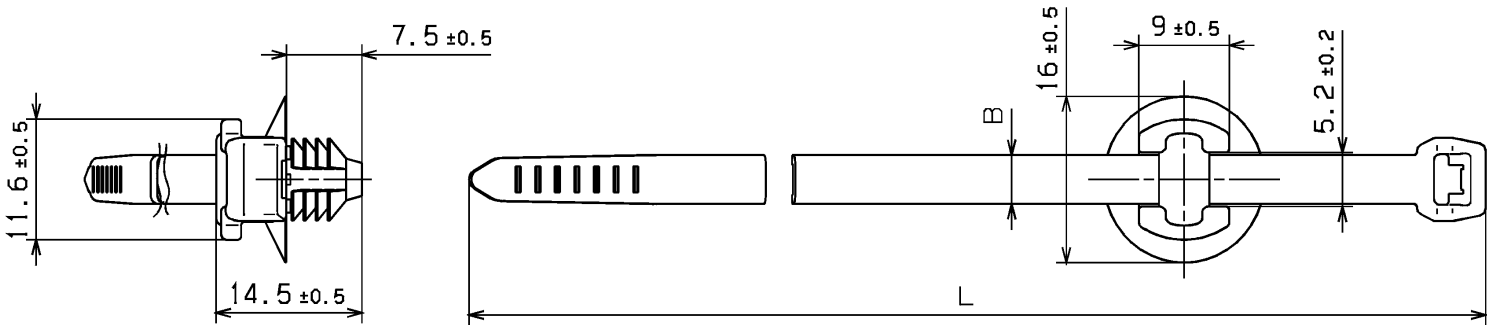


Loch Ø / Hole size
6,5 - 7±0,1mm
Blechdicke / Panel thickness
0,75 - 3mm
Buendel Ø /Bundle Diameter
siehe Tabelle / see table
Werkstoff / Material
a: PA6.6 schlagzäh, hitzebeständig, schwarz/ PA6.6 impact resistant mod., heatstabilised, black b: PA6.6 hitzebeständig, schwarz/ PA6.6 heatstabilised, black
Toleranzen / Tolerances
Masse ohne Toleranzangaben nach Dimension without tolerances details to DIN 16901 /
AUSFÜHRUNG / PERFORMANCE
SPEZIFIKATION / SPEC.

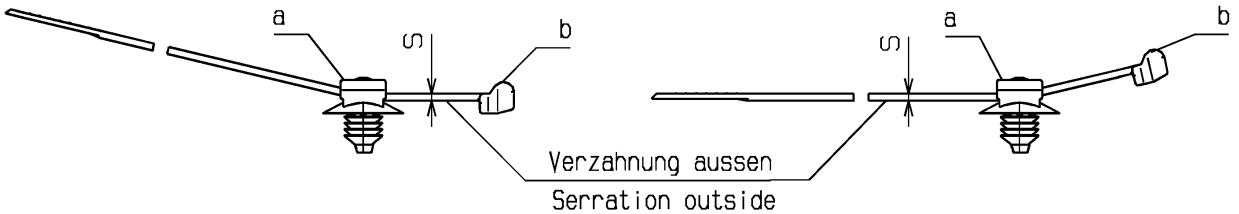
Nur zur Information,
wird vom Änderungsdienst
nicht erfaßt.
For information only,
not subject to alteration

Änderungsstand / Revision level		Beschreibung der Änderung/ Revision Record	Geändert Changed	Datum Date	Geprüft Approved	Datum Date
Solid / part	Zeichnung / drawing					

	Artikelbezeichnung/ product type	Laenge/ length L±10	Bandbreite/ strap width B±0,2	Dicke/ thickness S±0,2	Buendel/ bundle Ø
1	T50R0SFT6SD-MC5-BK	200	4,6	1,3	1-46
2	T50S0SFT6SD-MC5-BK	150	4,6	1,3	1-31



Lieferzustände / DELIVERY CONDITIONS 1:1



Bezeichnungsbeispiel:
a: Fussteil FT6SD
b: und Kabelbinder T50S0S
ist: Bef.-binder T50S0SFT6SD-MC5-BK

Example of designation:
a: Socket FT6SD
b: and cable tie T50S0S
being: Fixing tie T50S0SFT6SD-MC5-BK

CATIA 4.2.0		Gez. / Drawn	01.08.00	Steiner	Masstab / Scale	2:1, 1:1	NT 526/98
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		HellermannTyton			Befestigungsbinder/Fixing tie		
		HellermannTyton GmbH			...FT6SD		
		Grosser Moorweg 45, 25436 Tornesch Telefon: 04122 / 701-1 Telefax: 04122 / 701-400			Zeichnungs-Nr./Drawing-No		Format D. Size
					14.1463		A3
					Blatt Sheet		